

BAV199

DUAL SURFACE MOUNT LOW LEAKAGE DIODE

Features

Surface Mount Package Ideally Suited for Automatic Insertion

Very Low Leakage Current

Lead Free/RoHS Compliant (Note 3)

Mechanical Data

Case: SOT-23

Case Material: Molded Plastic. UL Flammability

Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Finish Matte Tin Solderable per MIL-STD-202,

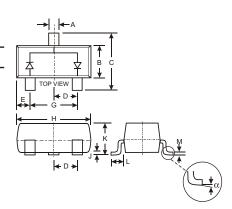
Method 208

Lead Free Plating (Matte Tin Finish annealed over Alloy 42

leadframe).

Polarity: See Diagram

Marking: K52 & Date Code (See Page 2) Weight: 0.008 grams (approximate)



	SOT-23										
Dim	Min	Max									
Α	0.37	0.51									
В	1.20	1.40									
С	2.30	2.50									
D	0.89	1.03									
E	0.45	0.60									
G	1.78	2.05									
Н	2.80	3.00									
J	0.013	0.10									
K	0.903	1.10									
L	0.45	0.61									
М	0.085	0.180									
	0	8									
All Din	nensions	in mm									

Maximum Ratings @ TA = 25 C unless otherwise specified

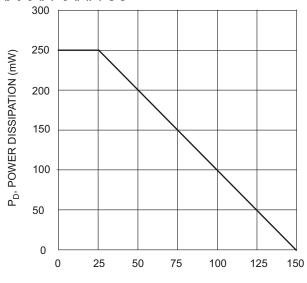
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	85	٧
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Continuous Current (Note 2) Single diode Double diode	I _{FM}	160 140	mA
Repetitive Peak Forward Current (Note 2)	I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current $@$ t = 1.0 s $@$ t = 1.0ms $@$ t = 1.0s	I _{FSM}	4.0 1.0 0.5	А
Power Dissipation (Note 2)	P _d	250	mW
Thermal Resistance Junction to Ambient Air (Note 2)	R _{JA}	500	C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	С

Electrical Characteristics @ TA = 25 C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	85			V	I _R = 100 A
Forward Voltage	V _F			0.90 1.0 1.1 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 1)	I _R			5.0 80	nA nA	$V_R = 75V$ $V_R = 75V$, $T_j = 150$ C
Total Capacitance	Ст		2		pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}			3.0	S	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100$

- Notes: 1. Short duration test pulse to minimize self-heating effect.
 - 2. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
 - 3. No purposefully added lead.





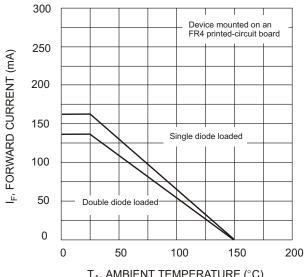
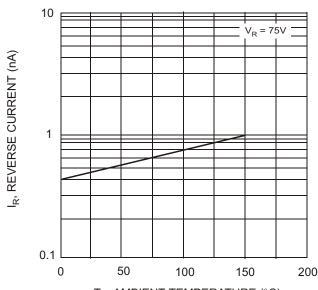


Fig. 1 Power Derating Curve 1000 I_F, INSTANTANEOUS FORWARD CURRENT (mA) 100 10 1.0

 T_A , AMBIENT TEMPERATURE (°C)

T_A, AMBIENT TEMPERATURE (°C) Fig. 2 Current Derating Curve



V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 3 Typical Forward Characteristics

T_A, AMBIENT TEMPERATURE (°C) Fig. 4 Typical Reverse Characteristics

Ordering Information (Note 4)

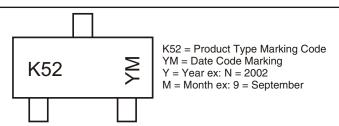
Device	Packaging	Shipping		
BAV199-7-F	SOT-23	3000/Tape & Reel		

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

0.1

0.01



Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
		-			-					-		

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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